## 1PS66SB82; 1PS88SB82

# 15 V, 30 mA low C<sub>d</sub> Schottky barrier diodes Rev. 04 — 13 January 2010

Product data sheet

#### 1. **Product profile**

#### 1.1 General description

Epitaxial low capacitance Schottky barrier diodes encapsulated in very small SMD plastic packages.

Table 1. **Product overview** 

Type number	Package		Configuration
	Nexperia	JEITA	
1PS66SB82	SOT666	-	triple isolated diode
1PS88SB82	SOT363	SC-88	triple isolated diode

#### 1.2 Features

- Low diode capacitance
- Low forward voltage
- Very small SMD plastic packages

#### 1.3 Applications

- Digital applications:
  - Ultra high-speed switching
  - Clamping circuits
- RF applications:
  - Diode ring mixer
  - RF detector
  - RF voltage doubler

#### 1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F</sub>	continuous forward current		-	-	30	mA
$V_R$	continuous reverse voltage		-	-	15	V
C <sub>d</sub>	diode capacitance	$V_R = 0 V$ ; f = 1 MHz; see <u>Figure 4</u>	-	1	-	pF



## 2. Pinning information

Table 3. Pinning

	9		
Pin	Description	Simplified outline	Symbol
1	anode (diode 1)		
2	anode (diode 2)	6   5   4	6 5 4
3	anode (diode 3)		
4	cathode (diode 3)		1 2 3
5	cathode (diode 2)		sym046
6	cathode (diode 1)	001aab555	

## 3. Ordering information

Table 4. Ordering information

Type number	Package				
	Name	Description	Version		
1PS66SB82	-	plastic surface mounted package; 6 leads	SOT666		
1PS88SB82	SC-88	plastic surface mounted package; 6 leads	SOT363		

## 4. Marking

Table 5. Marking codes

Type number	Marking code
1PS66SB82	N5
1PS88SB82	E1*

<sup>[1] \* = -:</sup> made in Hong Kong

## 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{R}$	continuous reverse voltage		-	15	V
I <sub>F</sub>	continuous forward current		-	30	mA
Tj	junction temperature		-	125	°C
T <sub>amb</sub>	ambient temperature		<b>–65</b>	+125	°C
T <sub>stg</sub>	storage temperature		<b>–65</b>	+150	°C

<sup>\* =</sup> p: made in Hong Kong

<sup>\* =</sup> t: made in Malaysia

<sup>\* =</sup> W: made in China

#### 6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	<u>[1]</u>			
	SOT666		[2][3]	-	700	K/W
	SOT363		[3][4]	-	416	K/W

<sup>[1]</sup> For Schottky barrier diodes thermal run-away has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses. Nomograms for determining the reverse power losses P<sub>R</sub> and I<sub>F(AV)</sub> rating will be available on request.

- [2] Refer to SOT666 standard mounting conditions.
- [3] Reflow soldering is the only recommended soldering method.
- [4] Refer to SOT363 (SC-88) standard mounting conditions.

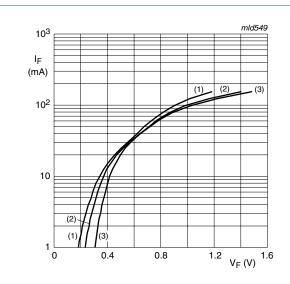
#### 7. Characteristics

Table 8. Characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

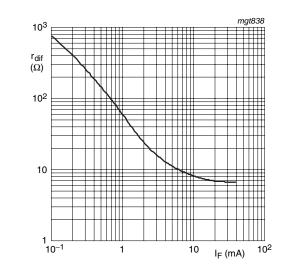
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{F}$	forward voltage	see Figure 1	<u>[1]</u>			
		I <sub>F</sub> = 1 mA	-	-	340	mV
		$I_F = 30 \text{ mA}$	-	-	700	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1 V; see Figure 2	-	-	0.2	μΑ
r <sub>dif</sub>	differential resistance	$I_F = 5 \text{ mA}$ ; $f = 1 \text{ kHz}$ ; see Figure 3	-	12	-	Ω
C <sub>d</sub>	diode capacitance	$V_R = 0 V$ ; $f = 1 MHz$ ; see Figure 4	-	1	-	pF

<sup>[1]</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 



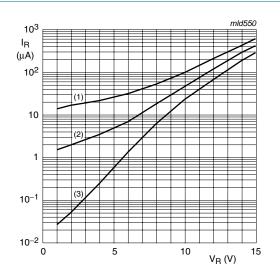
- (1)  $T_{amb} = 125 \, ^{\circ}C$
- (2)  $T_{amb} = 85 \, ^{\circ}C$
- (3)  $T_{amb} = 25 \, ^{\circ}C$

Fig 1. Forward current as a function of forward voltage; typical values



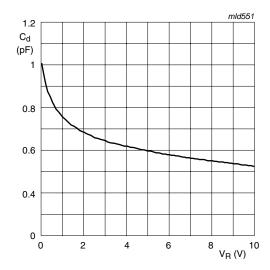
 $f = 1 \text{ kHz}; T_{amb} = 25 \text{ }^{\circ}\text{C}$ 

Fig 3. Differential diode forward resistance as a function of forward current; typical values



- (1)  $T_{amb} = 125 \, ^{\circ}C$
- (2)  $T_{amb} = 85 \, ^{\circ}C$
- (3)  $T_{amb} = 25 \, ^{\circ}C$

Fig 2. Reverse current as a function of reverse voltage; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 \,^{\circ}\text{C}$ 

Fig 4. Diode capacitance as a function of reverse voltage; typical values

## 8. Package outline

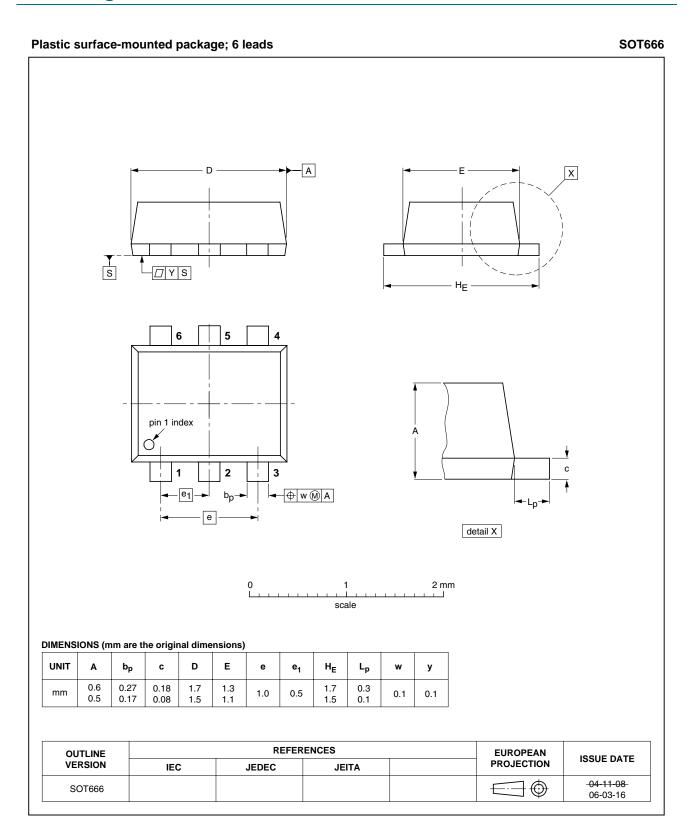


Fig 5. Package outline SOT666

#### Plastic surface-mounted package; 6 leads

**SOT363** 

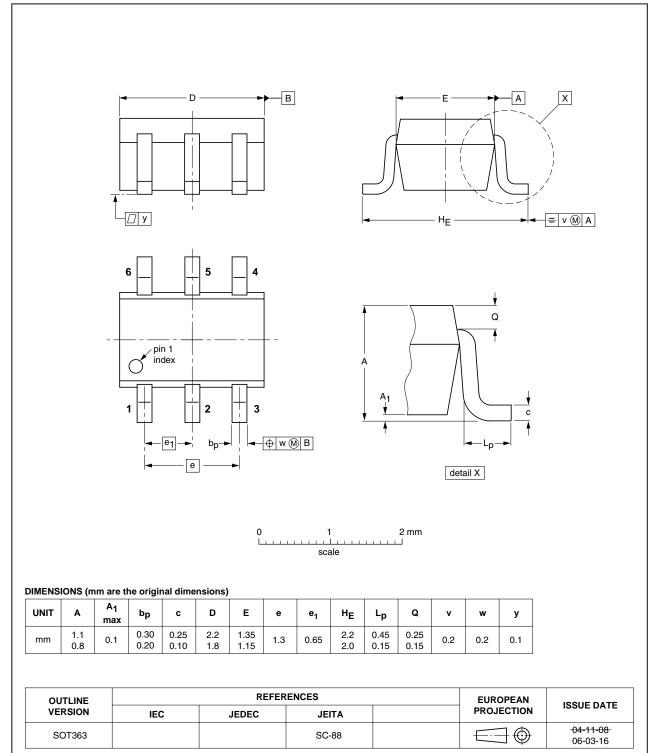


Fig 6. Package outline SOT363 (SC-88)

## **Packing information**

#### Table 9. **Packing methods**

The -xxx numbers are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity		
			3 000	4000	10 000
1PS66SB82	SOT666	4 mm pitch, 8 mm tape and reel	-	-115	-
1PS88SB82	SOT363	4 mm pitch, 8 mm tape and reel	-115	-	-135

<sup>[1]</sup> For further information and the availability of packing methods see Section 12.

## 10. Revision history

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
1PS66SB82_1PS88SB82_4	20100113	Product data sheet	-	1PS66SB82_1PS88SB82_3		
Modifications:		•	• •	name NXP Semiconductors, s were made to the technical		
	<ul> <li>Table 3 "Pinnir</li> </ul>	• Table 3 "Pinning": updated				
	<ul> <li>Figure 5 "Pack</li> </ul>	kage outline SOT666": u	pdated			
	<ul> <li>Figure 6 "Pack</li> </ul>	kage outline SOT363 (So	C-88)": updated			
1PS66SB82_1PS88SB82_3	20050124	Product data sheet	-	1PS88SB82_2		
1PS88SB82_2	20030411	Product specification	-	1PS88SB82_1		
1PS88SB82_1	20010216	Product specification	-	-		

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#### 11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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